

Feature

This device is Pb-Free, Halogen Free/BFR Free and RoHS compliant.

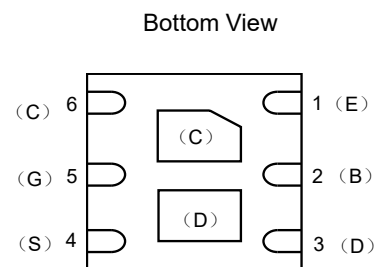
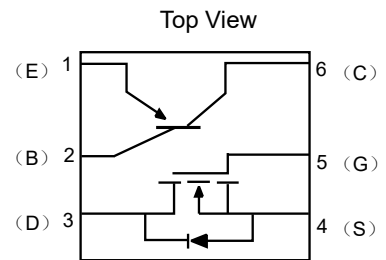
PNMT6N1 is composed by a transistor and a MOSFET

Transistor:

- Very low collector to emitter saturation voltage
- DC current gain >100
- 3A continuous collector current
- PNP epitaxial planar silicon transistor

MOSFET:

MOSFET Product Summary			
$V_{DS}(V)$	$R_{DS(on)}(\Omega)$	$V_{GS(th)}(V)$	$I_D(A)$
40	4.5@ $V_{GS}=4V$	0.5 to 1.5	0.18



- Transistor

Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Value	Units
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C = -10mA$	-30	V
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C = -0.1mA$	-40	V
Emitter -Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E = -0.1mA$	-5	V
Collector Current	I_C		-3	A
Collector Peak Current	I_{CM}		-6	A
Base Current	I_B		-0.2	A
Base Peak Current	I_{BM}		-0.5	A
Total Dissipation @25°C	P_{tot}		1.2	W
Storage Temperature	T_{stg}		-65~150	°C
Max. Operating Junction Temperature	T_j		150	°C
Junction-to-Ambient Thermal Resistance ⁽¹⁾	$R_{\theta JA}$		104	°C/ W

Note 1: Surface mounted on FR-4 Board using 1 square inch pad size, 1oz copper

Absolute maximum rating@25°C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
DC Current Gain	h_{FE}	$I_C=-1mA, V_{CE}=-5.0V$	150			-
		$I_C=-1A, V_{CE}=-5.0V$	100		-	
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=-0.1A, I_B=-1mA$	-		-0.14	V
		$I_C=-0.5A, I_B=-50mA$	-		-0.17	
		$I_C=-1A, I_B=-100mA$	-		-0.31	
Base-Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=-1A, I_B=-0.05mA$			-1.1	V
Collector Cut-off Current ($I_E=0$)	I_{CBO}	$V_{CB}=-40V$			-0.1	μA
		$V_{CB}=-30V, T_C=125^\circ C$			-20	
Emitter Cut-off Current($I_C=0$)	I_{EBO}	$V_{EB}=-5V$			-0.1	μA

MOSFET
Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	V_{DSS}	$I_D=10\mu A, V_{GS}=0V$	40	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=35V, V_{GS}=0V$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 15V$	-	-	± 1	μA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	-	1.5	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=4.5V, I_D=0.2A$	-	-	4	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{GS}=0V, V_{DS}=25V,$ $f=1MHz$	-	-	40	pF
Output Capacitance	C_{DSS}		-	-	20	pF
Reverse Transfer Capacitance	C_{RSS}		-	-	5	pF
SWITCHING PARAMETERS						
Turn-On Delay Time	$t_{d(on)}$	$V_{DS}=30V, V_{GS}=10V,$ $R_G=25\Omega, R_L=150\Omega$ $I_D=0.2A$	-	-	20	ns
Turn-Off Delay Time	$t_{d(off)}$		-	-	20	ns

Absolute maximum rating@25°C

Rating		Symbol	Value	Units
Drain-Source Voltage		V_{DS}	40	V
Gate-Source Voltage		V_{GS}	± 20	V
Drain Current	Continuous	I_D	0.18	A
	Pulsed	I_D	0.36	A
Total Power Dissipation	$T_A=25^\circ\text{C}$	P_D	150	mW

Typical Characteristics

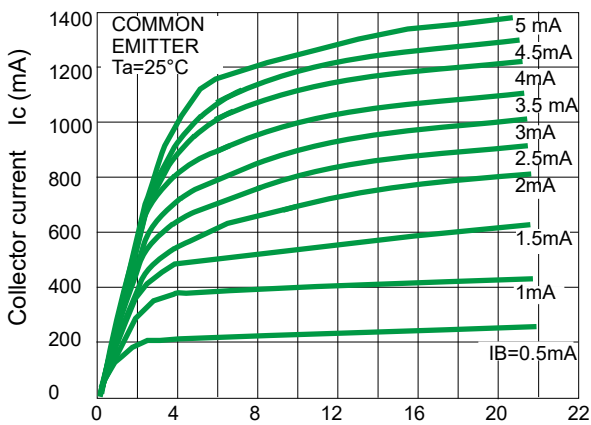


Fig1. Collector-emitter voltage V_{CE} (V)

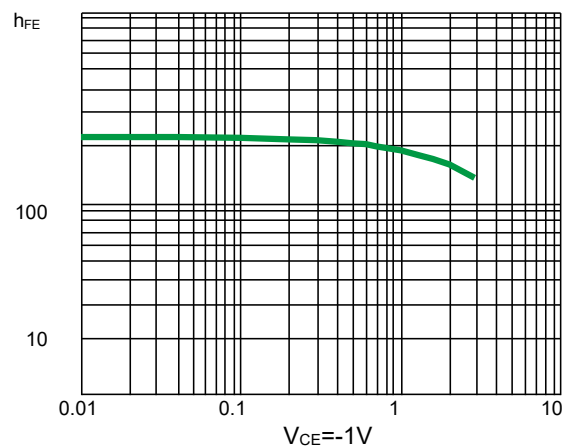


Fig2. DC Current Gain

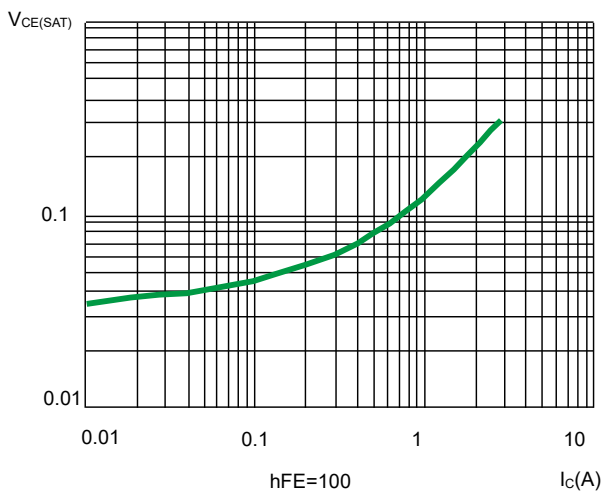


Fig 3. Collector-Emitter Saturation Voltage

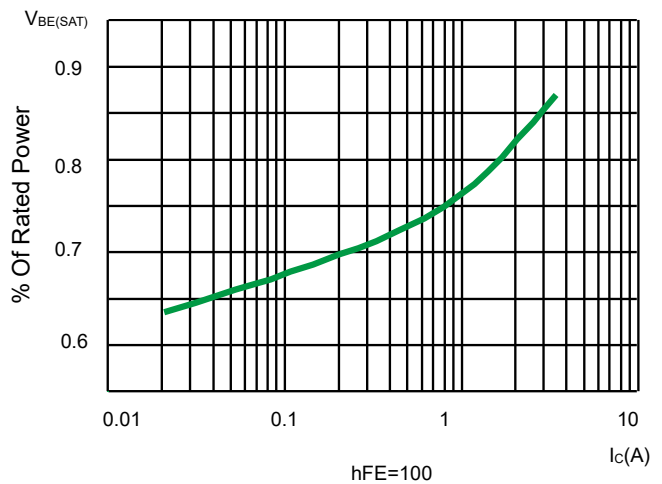


Fig4. Base-Emitter Saturation Voltage

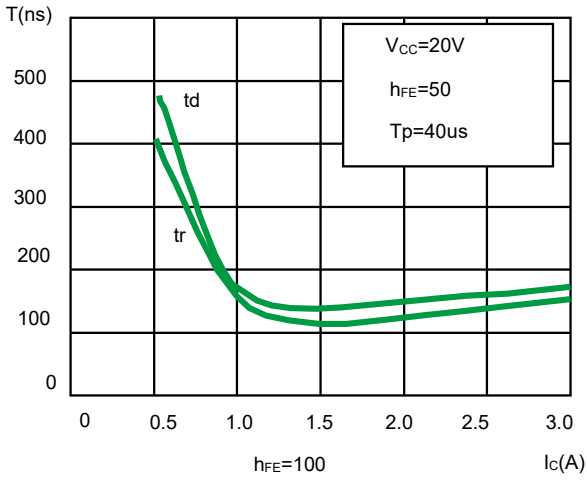


Fig 5. Switching Times Resistive Load

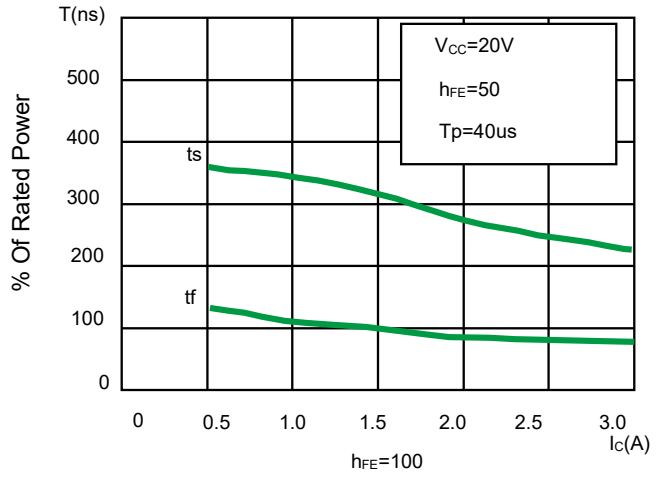


Fig 6. Switching Times Resistive Load

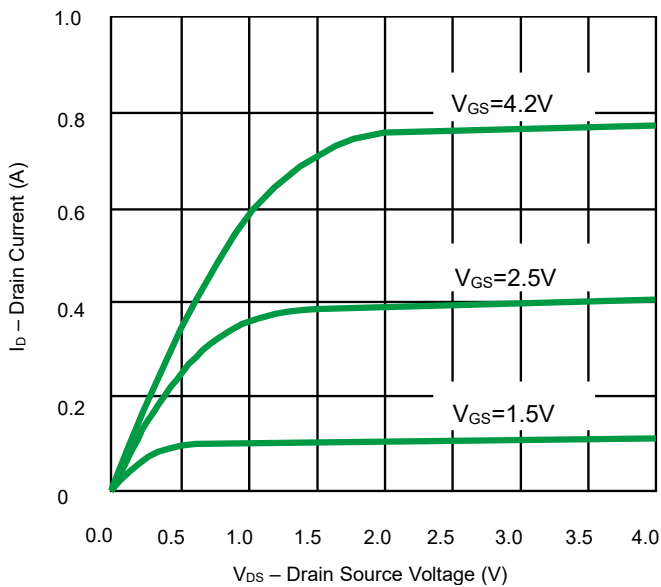


Fig 7. Output Characteristics

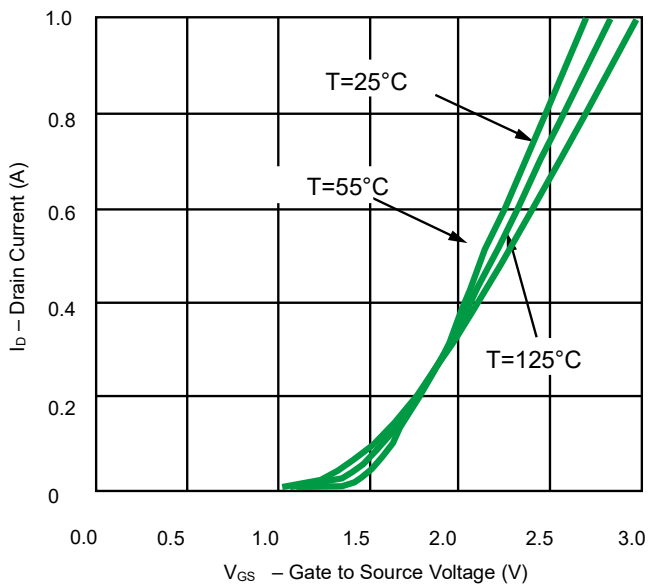


Fig 8. Transfer Characteristics

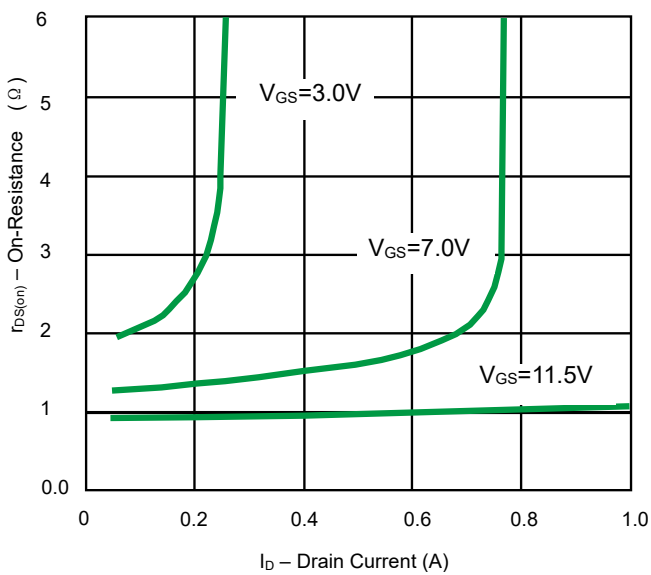


Fig 9. On-Resistance vs. Drain Current

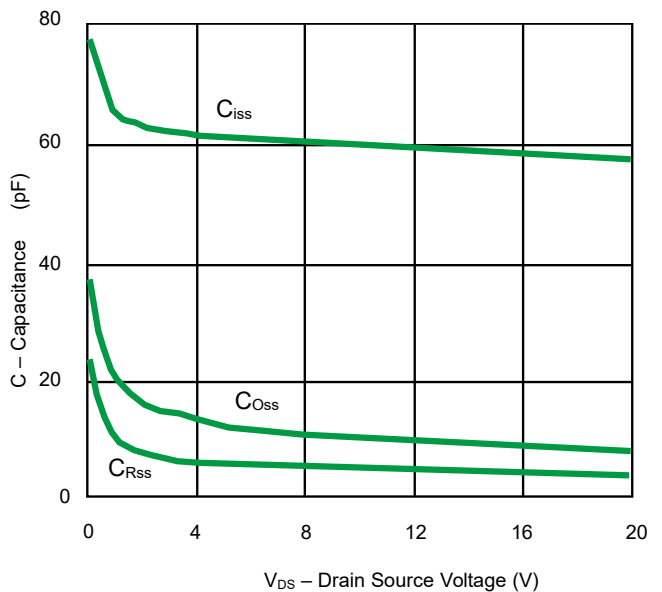


Fig 10. Capacitance

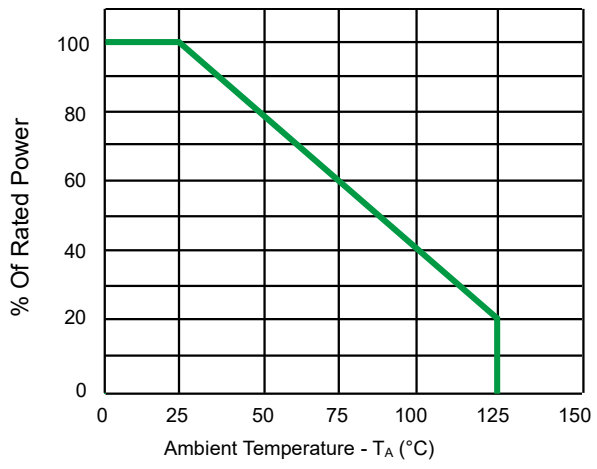
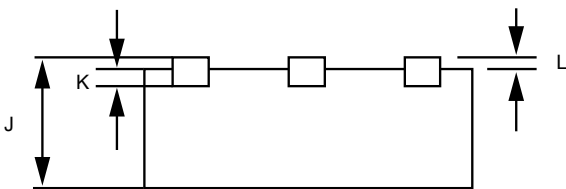
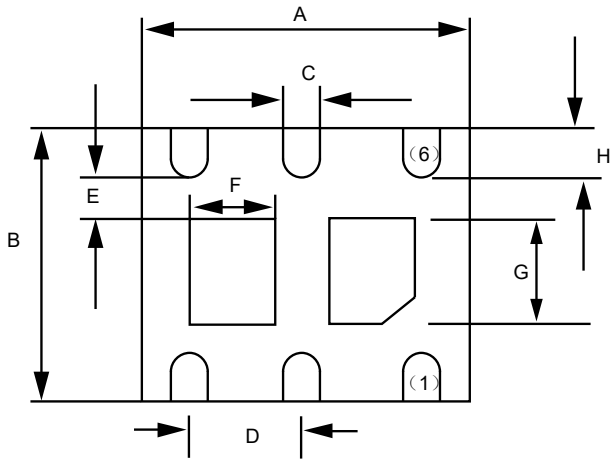
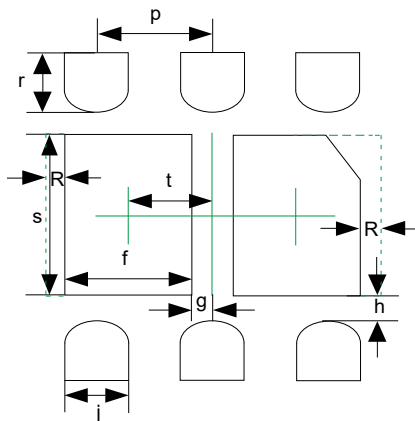


Fig11. Power Derating Curve

Product dimension DFN-6L(2*2)



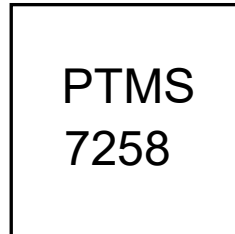
Dim	Millimeters		Inches	
	MIN	MAX	MIN	MAX
A	1.924	2.076	0.076	0.082
B	1.924	2.076	0.076	0.082
C	0.250	0.350	0.010	0.014
D	0.650 (typ.)		0.026 (typ.)	
E	0.200 MIN.		0.008 MIN.	
F	0.520	0.720	0.020	0.028
G	0.900	1.100	0.035	0.043
H	0.174	0.326	0.007	0.013
J	0.550	0.650	0.021	0.027
K	0.206 REF		0.206 REF	
L	0.203 REF		0.203 REF	



If there is enough place in PCB. It can be mounted with copper along the dotted line in order to optimize thermal design.

Dim	Millimeters	
	MIN	MAX
p	0.60	0.70
r	0.40	0.50
s	1.05	1.15
t	0.42	0.52
f	0.67	0.77
g	0.06	0.16
h	0.1	0.2
j	0.35	0.45
R	0.1	0.2

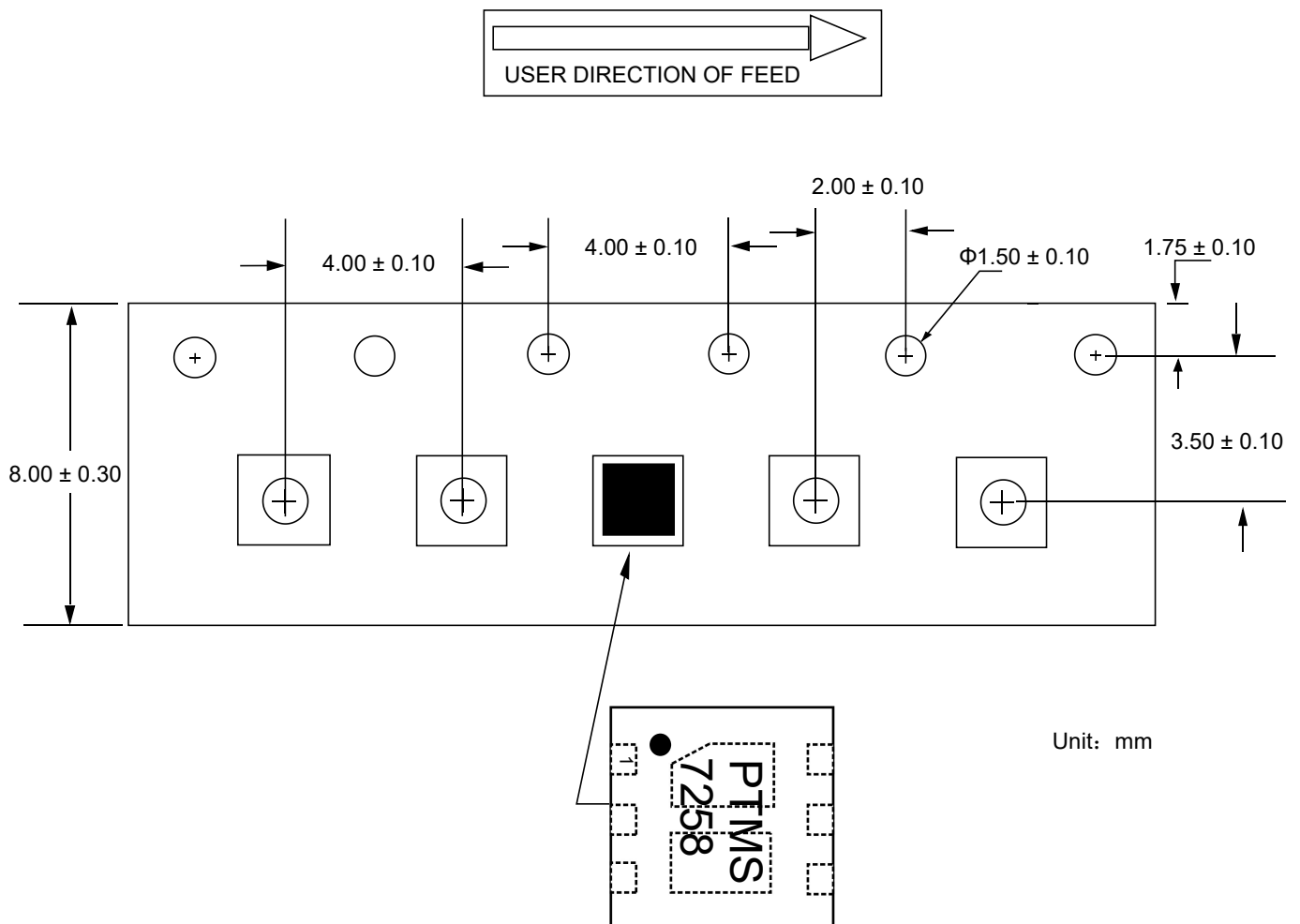
Marking information




Ordering information

Device	Package	Reel	Shipping
PNMT6N1	DFN-6L (2*2)	7"	3000 / Tape & Reel

Load with information




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